

C1206X155K8NACTU

Aliases (C1206X155K8NAC7800)

SMD Comm X8L HT150C, Ceramic, 1.5 uF, 10%, 10 VDC, X8L, SMD, MLCC, High Temperature, Temperature Stable, 1206



Click [here](#) for the 3D model.

Dimensions	
Chip Size	1206
L	3.3mm +/-0.4mm
W	1.6mm +/-0.35mm
T	1.6mm +/-0.20mm
B	0.6mm +/-0.25mm

Packaging Specifications	
Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	2000

General Information	
Series	SMD Comm X8L HT150C
Style	SMD Chip
Description	SMD, MLCC, High Temperature, Temperature Stable
Features	High Temperature, Temperature Stable
RoHS	Yes
Termination	Flexible Termination
Marking	No
AEC-Q200	No
Component Weight	41 mg
Shelf Life	78 Weeks
MSL	1

Specifications	
Capacitance	1.5 uF
Measurement Condition	1 kHz 1.0Vrms
Capacitance Tolerance	10%
Voltage DC	10 VDC
Dielectric Withstanding Voltage	25 VDC
Temperature Range	-55/+150°C
Temperature Coefficient	X8L
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	+15%/-40%, 1kHz 1.0Vrms
Dissipation Factor	3.5% 1 kHz 1.0Vrms
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	333.3 MOhms

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